INTEGRATED CIRCUITS

DATA SHEET

74ALS164

8-bit serial-in parallel-out shift register

Product specification IC05 Data Handbook





8-bit serial-in parallel-out shift register

74ALS164

FEATURES

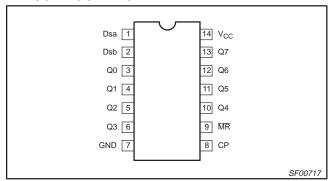
- Gated serial data inputs
- Typical shift frequency of 75MHz
- Asynchronous master reset
- Buffered clock and data inputs
- Fully synchronous data transfer

DESCRIPTION

The 74ALS164 is an 8-bit edge-triggered shift register with serial data entry and an output from each of the eight stages. Data is entered serially through one of two inputs (Dsa, Dsb); either input can be used as an active-high enable for data entry through the other input. Both inputs must be connected together or an unused input must be tied High.

Data shifts one place to the right on each Low-to-high transition of the clock (CP) input, and enters into Q0 the logical AND of the two data inputs (Dsa, Dsb) that existed one setup time before the rising edge. A Low level on the Master reset (\overline{MR}) input overrides all other inputs and clears the register asynchronously, forcing all outputs Low.

PIN CONFIGURATION



TYPE	TYPICAL f _{MAX}	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS164	75MHz	10mA

ORDERING INFORMATION

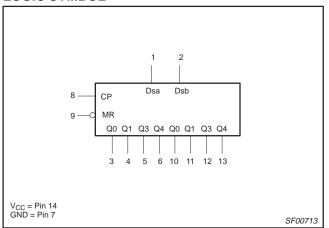
	ORDER CODE		
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V $\pm 10\%$, T_{amb} = 0°C to ± 70 °C	DRAWING NUMBER	
14-pin plastic DIP	74ALS164N	SOT27-1	
14-pin plastic SO	74ALS164D	SOT108-1	

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

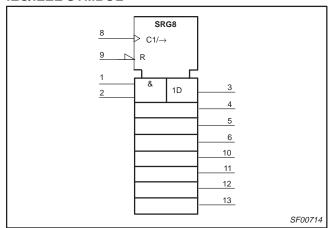
PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Dsa, Dsb	Data inputs	1.0/1.0	20μA/0.1mA
СР	Clock Pulse input (active rising edge)	1.0/1.0	20μA/0.1mA
MR	Master Reset input (active-Low)	1.0/1.0	20μA/0.1mA
Q0 – Q7	Data outputs	20/80	0.4mA/8mA

 $\textbf{NOTE:} \quad \text{One (1.0) ALS unit load is defined as: } 20\mu\text{A in the High state and 0.1mA in the Low state.}$

LOGIC SYMBOL



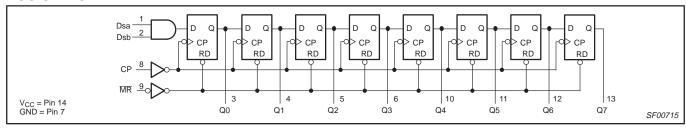
IEC/IEEE SYMBOL



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LOGIC DIAGRAM



MODE SELECT FUNCTION TABLE

	INP	UTS					OUT		OPERATING MODE					
MR	СР	Dsa	Dsb	Q0	Q1	Q2	Q3	Q4	Q5	Q6	Q7	OPERATING MODE		
L	Х	Х	Х	L	L	L	L	L	L	L	L	Reset (Clear)		
Н	1	I	I	L	q0	q1	q2	q3	q4	q5	q6			
Н	1	I	h	L	q0	q1	q2	q3	q4	q5	q6	Shift		
Н	1	h	I	L	q0	q1	q2	q3	q4	q5	q6	Stillt		
Н	1	h	h	Н	q0	q1	q2	q3	q4	q5	q6			

NOTES:

H = High voltage level
h = High voltage level one setup time prior to the Low-to-High clock transition

Low voltage level one setup time prior to the Low-to-High clock transition

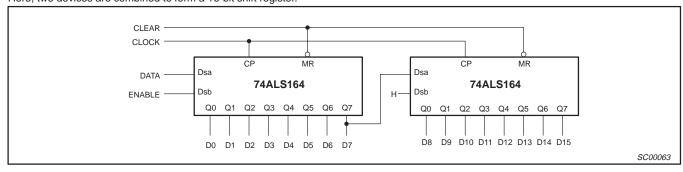
qn = Lower case letter indicate the state of the referenced output one setup time prior to the Low-to-High clock transition.

Don't care =

Low-to-High clock transition

APPLICATION

The 74ALS164 can be cascaded to form synchronous shift registers of longer length. Here, two devices are combined to form a 16-bit shift register.



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ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	−30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	−0.5 to V _{CC}	V
I _{OUT}	Current applied to output in Low output state	16	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT		
STIMBOL	PARAMETER	MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
I _{lk}	Input clamp current			-18	mA
I _{OH}	High-level output current			-0.4	mA
I _{OL}	Low-level output current			8	mA
T _{amb}	Operating free-air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDIT	IONE1		LIMITS		UNIT
STWIBUL	PARAMETER	TEST CONDIT	ION3·	MIN	TYP ²	MAX	UNII
V _{OH}	High-level output voltage	$V_{CC}\pm 10\%$, $V_{IL}=MAX$, $V_{IH}=V_{CC}\pm 10\%$	= MIN, I _{OH} = MAX	V _{CC} – 2			V
V	Low level output voltage	V _{CC} = MIN, V _{IL} = MAX,	I _{OL} = 4mA		0.25	0.4	V
V _{OL}	Low-level output voltage	V _{IH} = MIN	I _{OL} = 8mA		0.35	0.50	V
V _{IK}	Input clamp voltage	$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.5	V
lı	Input current at maximum input voltage	$V_{CC} = MAX, V_I = 7.0V$				100	μΑ
I _{IH}	High-level input current	$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
I _{IL}	Low-level input current	$V_{CC} = MAX, V_I = 0.5V$				-0.1	mA
Io	Output current ³	$V_{CC} = MAX, V_O = 2.25V$		-30		-112	mA
I _{CC}	Supply current (total)	V _{CC} = MAX			10	15	mA

NOTES

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2. All typical values are at V_{CC} = 5V, T_{amb} = 25°C.

3. The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, Ios.

AC ELECTRICAL CHARACTERISTICS

			LIM	ITS	
SYMBOL	PARAMETER	TEST CONDITION	T _{amb} = 0°C V _{CC} = +5. C _L = 50pF,	UNIT	
			MIN	MAX	
f _{MAX}	Maximum clock frequency	Waveform 1	50		MHz
t _{PLH} t _{PHL}	Propagation delay CP to Qn	Waveform 1	5.0 6.0	13.0 15.0	ns
t _{PHL}	Propagation delay, MR to Qn	Waveform 2	8.0	18.0	ns

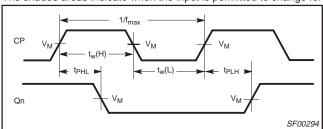
AC SETUP REQUIREMENTS

			LIM	ITS	
SYMBOL	PARAMETER	TEST CONDITION	$V_{CC} = +5.$	C to +70°C 0V ± 10% R _L = 500Ω	UNIT
			MIN	MAX	
t _{su} (H) t _{su} (L)	Setup time, High or Low Dn to CP	Waveform 3	6.0 5.0		ns
t _h (H) t _h (L)	Hold time, High or Low Dn to CP	Waveform 3	0 0		ns
t _w (H) t _w (L)	Clock pulse width, High or Low	Waveform 1	10.0 7.0		ns
t _w (L)	MR pulse width, Low	Waveform 2	6.0		ns
t _{REC}	Recovery time, MR to CP	Waveform 2	6.0		ns

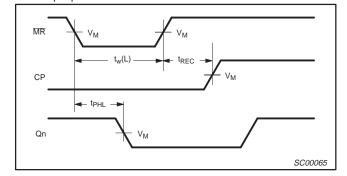
AC WAVEFORMS

For all waveforms, $V_M = 1.3V$.

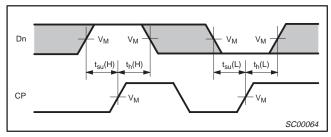
The shaded areas indicate when the input is permitted to change for predictable output performance.



Waveform 1. Propagation Delay for Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency



Waveform 2. Master Reset Pulse Width, Master Reset to Output Delay, and Master Reset to Clock Recovery Time



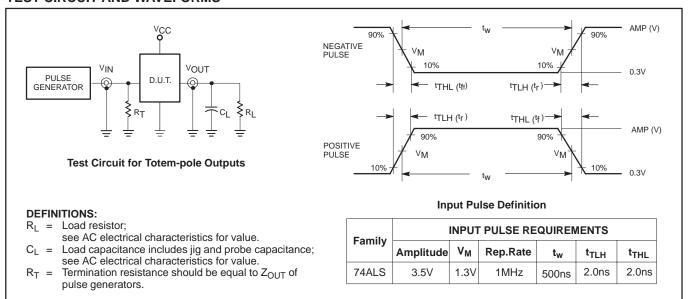
Waveform 3. Data Setup and Hold Times

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TEST CIRCUIT AND WAVEFORMS



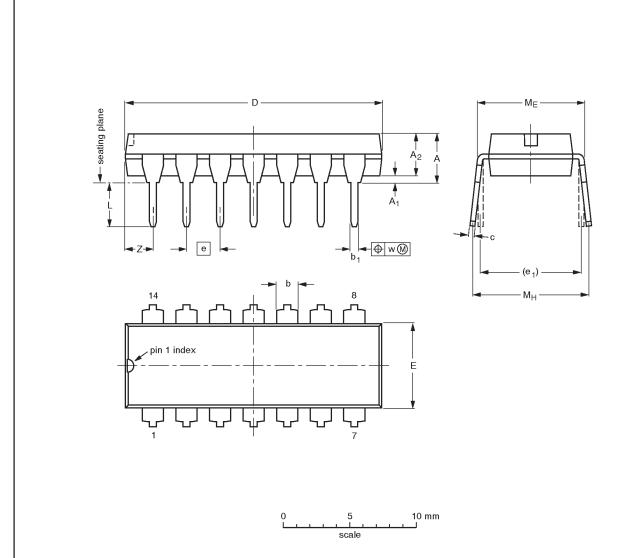
SC00005

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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC		PROJECTION	ISSUE DATE	
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11

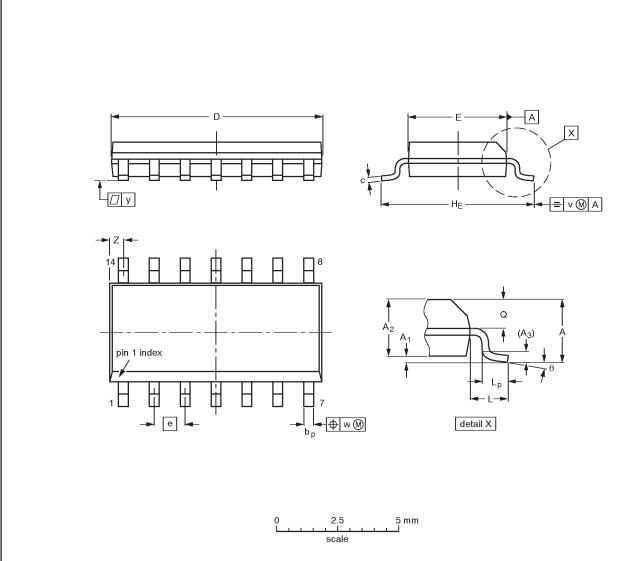
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8-bit serial-in parallel-out shift register

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Ø	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01		0.0098 0.0075		0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

	OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE		
		IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
	SOT108-1	076E06\$	MS-012AB				91-08-13 95-01-23	

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DEFINITIONS						
Data Sheet Identification	Product Status	Definition				
Objective Specification	Formative or in Design	data sheet contains the design target or goal specifications for product development. Specifications or change in any manner without notice.				
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.				
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